PCN Number:		20230512000.2						PCN Date:	May 15, 2023		
Title: Qualification		of TI Philippines as an additional Test site for select devices									
Customer Contact:		PCN Manager		Dept:	ept: Quality Se		ervic	vices			
Proposed 1 st Ship Date		: Nov 15, 202		23	Sample requests accepted until						
Change Type:											
Assembly Site			Design				Ц	Wafer Bump Material			
Assembly Process				ᄔ	Data Sheet			Ц	Wafer Bump Process		
Assembly Materials				닏	Part number change			<u> </u>	Wafer Fab Site		
Mechanical Specific						Test Site			Wafer Fab		
Packing/Shipping/La			abeling	Ш	Test Process				Wafer Fab Process		
PCN Details											
Description of Change:											
Texas Instruments Incorporated has qualified TI Philippines as additional Test site for the devices listed below to support high volume ramps.											
		Current:				New:					
Test Site			LEN				TIP	TI Philippines			
Test coverage, insertions, conditions will remain consistent with current testing.											
Reason for Change:											
Continuity of supply.											
Com	tinuity	of supply.									
	<u>`</u>	of supply. ed impact on	Form, Fit	, Fui	nction, (Quality	or Reliabi		(positive /	negative):	
	icipate		Form, Fit	, Fui	nction, (Quality	or Reliabi		(positive /	negative):	
None	icipate e								(positive /	negative):	
None	icipate e inges t	ed impact on							(positive /	negative):	
None Cha	e e nges	ed impact on							(positive /	negative):	
None Cha None Pro	e e e e e e	ed impact on		on re	sulting	from th		lity	(positive /	negative):	

ZVEI ID reference: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail				
WW PCN Team	PCN ww admin team@list.ti.com				

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